

January 2015

Inductors for Power Circuits

Wound Ferrite

VLF-M Series

VLF252012MT Type

VLF252012MT



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS	
 The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humid or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. 	ity: 10 to 75% RH
○ Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).	
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and closes not exceed 150°C.	nip temperature
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.	
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.	the chip due to
 Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for th design. 	e set thermal
 Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. 	
Use a wrist band to discharge static electricity in your body through the grounding wire.	
On not expose the products to magnets or magnetic fields.	
On not use for a purpose outside of the contents regulated in the delivery specifications.	
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommune equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose perform quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious equality.	measurement
society, person or property. If you intend to use the products in the applications listed below or if you have special requirements exceeding the ra	nge or conditions

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Inductors for Power Circuits

Wound Ferrite

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of VLF252012MT Type

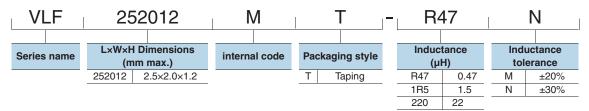
FEATURES

- Magnetic shield type wound inductor for power circuits.
- A DC-DC converter with top-class voltage conversion efficiency for similar products was achieved by optimizing the magnetic material and configuration.
- O Low-profile product.
- O High magnetic shield construction and compatible with high-density mounting.
- Halogen-free compatible product.

APPLICATION

Smart phones, tablet terminals, HDDs, SSDs, DVCs, DSCs, mobile display panels, portable game devices, compact power supply modules, other

■ PART NUMBER CONSTRUCTION



■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range	Package quantity	Individual weight
Type	Operating	Storage		
temperature*		temperature**		
	(°C)	(°C)	(pieces/reel)	(g)
VLF252012MT	-40 to +105	-40 to +105	2000	0.021

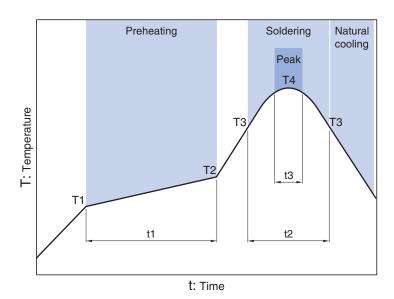
^{*} Operating temperature range includes self-temperature rise.

^{**} The Storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/

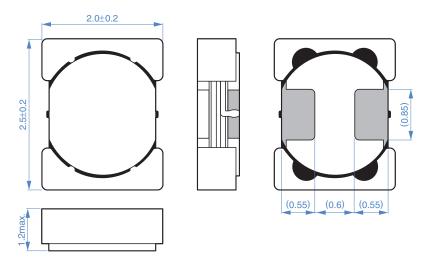
O Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

■ RECOMMENDED REFLOW PROFILE



Preheating Soldering Peak Temp. Temp. Time Time Temp. Time T1 T2 T4 Т3 t3 150°C 180°C 60 to 120s 230°C 30s 260°C 10s

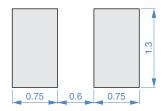
■SHAPE & DIMENSIONS





Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm

■ ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

L		Measuring frequency	DC resista	nce	Rated curr	rent*		Part No.
(1D	T-1	(BALL_)	(0)	(O)t	ldc1	ldc1	ldc2	
(μH)	Tolerance	(MHz)	(Ω)max.	(Ω)typ.	(A)max.	(A)typ.	(A)typ.	
0.47	±30%	1.0	0.029	0.024	1.89	2.10	3.45	VLF252012MT-R47N
0.68	±30%	1.0	0.038	0.032	1.55	1.72	3.04	VLF252012MT-R68N
1.0	±30%	1.0	0.052	0.043	1.30	1.44	2.47	VLF252012MT-1R0N
1.5	±30%	1.0	0.069	0.057	1.10	1.22	2.17	VLF252012MT-1R5N
2.2	±20%	1.0	0.10	0.09	0.94	1.04	1.67	VLF252012MT-2R2M
3.3	±20%	1.0	0.15	0.13	0.70	0.78	1.39	VLF252012MT-3R3M
4.7	±20%	1.0	0.22	0.18	0.62	0.69	1.09	VLF252012MT-4R7M
6.8	±20%	1.0	0.34	0.28	0.504	0.56	0.89	VLF252012MT-6R8M
10.0	±20%	1.0	0.41	0.34	0.41	0.46	0.78	VLF252012MT-100M
15.0	±20%	1.0	0.68	0.57	0.33	0.37	0.63	VLF252012MT-150M
22.0	±20%	1.0	1.00	0.83	0.28	0.31	0.46	VLF252012MT-220M

^{*} Rated current: smaller value of either ldc1 or ldc2.

Idc1: When based on the inductance change rate (30% below the nominal value)

Idc2: When based on the temperature increase (Temperature increase of 40°C by self heating)

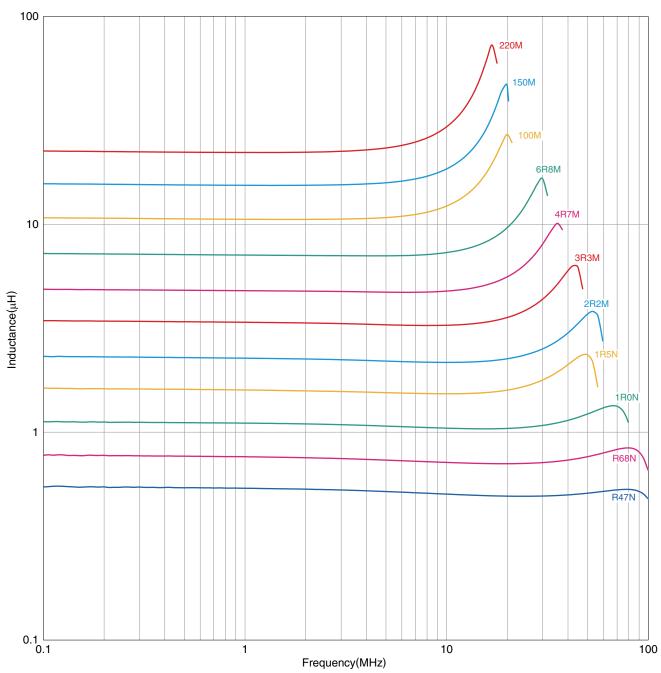
O Measurement equipment

Measurement item	Product No.	Manufacturer
L	4294A	Agilent Technologies
DC resistance	VP-2941A	Panasonic
Rated current Idc1	4285A+42841A+42842C	Agilent Technologies

^{*} Equivalent measurement equipment may be used.

ELECTRICAL CHARACTERISTICS

☐ L FREQUENCY CHARACTERISTICS GRAPH



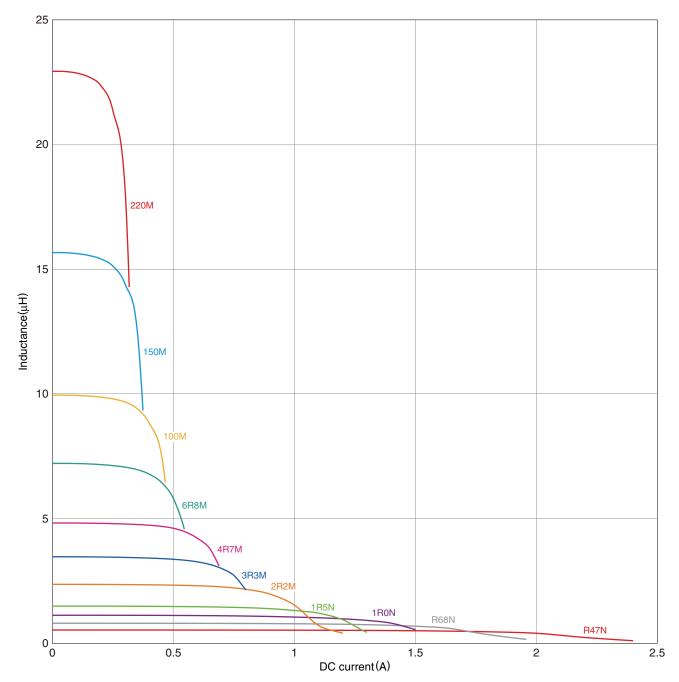
 \bigcirc Measurement equipment

Product No.	Manufacturer
4294A	Agilent Technologies

^{*} Equivalent measurement equipment may be used.

■ ELECTRICAL CHARACTERISTICS

□INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



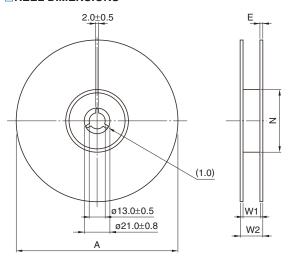
O Measurement equipment

Product No.	Manufacturer
4285A+42841A+42842C	Agilent Technologies

^{*} Equivalent measurement equipment may be used.

■PACKAGING STYLE

REEL DIMENSIONS



* These	values are	e typical	values.

Α

ø180

W1

W2

Ν

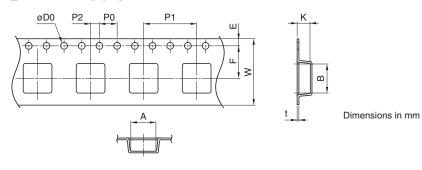
Ε

0.5

Type

VLF252012MT

TAPE DIMENSIONS



Type	Α	В	øD0	E	F	P0	P1	P2	W	K	t
VLF252012MT	2.3	2.8	1.5+0.1/-0	1.75±0.1	3.50±0.1	4.0±0.1	4.00±0.1	2.00±0.05	8.00±0.2	1.35	0.25

Dimensions in mm

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TDK:

<u>VLF252012MT-220M</u> <u>VLF252012MT-R47N</u> <u>VLF252012MT-2R2M</u> <u>VLF252012MT-1R5N</u> <u>VLF252012MT-150M</u> <u>VLF252012MT-100M</u> <u>VLF252012MT-R68N</u> <u>VLF252012MT-1R0N</u> <u>VLF252012MT-6R8M</u> <u>VLF252012MT-3R3M</u> <u>VLF252012MT-4R7M</u>